04-02-2001

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SHEET

U.S. Department of Commerce Patent and Trademark Office

To the Honorable Commissioner of Pat

101654427

original documents or copy thereof

Name of conveying party(ies):		2. Name and address of receiving party(ies):
Scott Moore		Name: Micron Technology, Inc.
Additional name(s party(ies) attached 3. Nature of Conv X Assignment Security Agreed Other Execution Date(s)	eyance: Merger Change of Name	Internal Address: Street Address: 8000 S. Federal Way City: Boise State: Idaho Zip: 83706-9632 Country: USA Additional name(s) & x Yes address(es) attached?
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the Execution date(s) of the new application is (are): A. Patent Application No.(s): B. Patent No.(s):		
Additional numbers attached? Yes 5. Name and address of party to whom correspondence 6. Total number of applications and		
concerning document should be mailed:		patents involved:
Name: DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP		7. Total fee (37 C.F.R 3.41) \$\$40.00
Internal Address:	Atty. Dkt.: M4065.0187/P187	x Enclosed
Attn	: Mark J. Thronson	Authorized to be charged to deposit account
Street Address:	2101 L Street NW	Credit any overpayment or debit any underpayment
City: Washington	State: Zip: DC 20037-1526	8. Deposit account number: 04-1073
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9. Statement and signature.		
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.		
Thomas J. D'Amico		August 30, 1999
Signature		Date
Reg. No. 28,371		
Total number of pages including cover sheet, attachments, and document:		

1045647 v1; M#TR011.DOC 1045647 v1; M#TR011.DOC

Docket No.: M4065.0187/P187 Micron No.: 98-1256

ASSIGNMENT AND AGREEMENT

For value received, I, Scott E. Moore hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled ELECTROPLATING APPARATUS AND METHOD, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

PATENT REEL: 011626 FRAME: 0917

Docket No.: M4065.0187/P187 Micron No.: 98-1256

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

United States of America
State of Odaho | Ss.:
County of | On this | 25 | day of | Quant | , 1999 | , before me personally came | Scott E. Moore | , to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.

RECORDED: 03/21/2001

PATENT REEL: 011626 FRAME: 0918